

Product Specification :	ISSUED BY: Engineering Dept		
Subject :	Date Issued	2012/07/22	
1.25mm Pitch SCT1252 Series Connector Specification	Date Revised	2013/09/05	

This specification is referred to the 1.25mm series wire to board connector

INDEX

- 1. Scope
- 2. Spec and Part number
- 3. Disposal of Material and surface
- 4. Ratings and applicable wires
- 5. Performance
 - 5-1. Electrical Performance.
 - 5-2. Mechanical Performance
 - 5-3. Environmental Performance and Others
- 6. Insertion/Withdrawal Force
- 7. SMT Infrared Reflow Condition

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1. Scope

This Specification Covers the 1.25mm Pitch SCT1252 Series Connector Specification.

2. Spec and Part number

Specification	Production No.	Picture of Product
Terminal	SCT1252TPx104	NONE
Housing	SCT1252H-xxBBE104 SCT1252H-2xxBGR104	NONE
Wafer	SCT1252WV-xxBxBE140 SCT1252WR-xxBxBE140 SCT1252WVSF-2xxExBE101	NONE

3. Disposal of Material and surface

Specification		Materials	Disposal of Surface
Terminal		Phosphor Bronze	Tin Plated:Over 70 $\mu^{\prime\prime}$,Nickel: Over 30 $\mu^{\prime\prime}$.
Housing		PA46	UL 94V-0
Wafer	Base	High Temperature Plastic/PA66	UL 94V-0
PIN		Phosphor Bronze/Brass	Over Tin 70µ″ Plated Over 30µ″ Nickel
	Solder tab	Phosphor Bronze/Brass	Over Tin 70µ″ Plated Over 30µ″ Nickel

(Please Refer to the Project drawing for the above Specification)

4. Ratings and applicable wires

Item	Standard		
Rated Voltage (Max.)	150V	[AC/DC]	
Rated Current (Max.)	1.0A		
Ambient temperature Range	-30℃~+85℃		
Applicable wire insulation O.D	AWG 26#~30# Insulation O.D. 1.00mm(Max.)		

^{*}Including terminal temperature rise.

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5. PERFORMANCE

5-1. Electrical Performance.

Item		Test Condition	Requirement
		Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	
5-1-1	Contact Resistance	A B	Initial: 30 milliohms Max. After Test: 60 milliohms Max.
5-1-2	Insulation Resistance	Mate connectors, apply 100V DC between adjacent terminal or ground. (Based upon EIA-364-21B/MIL-STD-202 Method 302 Cond.B)	500 Megohms Min.
5-1-3	Dielectric Strength	Mate connectors, apply 500V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A/MIL-STD-202 Method 301)	No Breakdown and Flashover
5-1-4	Contact resistance on crimped portion	Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	10 milliohms Max.

5-1. Electrical Performance

Item		Test Condition	Requirement
		Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.	Refer to paragraph 6

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5-2. Mechanical Performance.

Item		Test Condition	Requireme	nt		
5-2-2	Terminal /Housing Retention Force	Apply axial pull out force at the rate of 25.4±3mm/minute terminal assembled in the housing.	4.9N {0.5kgf} Min.			
5-2-3	Terminal Insertion Force	Insert the crimped terminal into the housing.	4.9N {0.5kg	4.9N {0.5kgf} Max.		
5-2-4	Pin Retention Force	Apply axial push force at the speed of 25.4±3mm/minute.	0.98N {0.1kgf} Min.			
		Fix the crimped terminal, apply axial pull out force on the wire. (Do not crimp insulation	AWG# Spec.kgf.	#26	#28	#30
	Tensile	part).	Min.	1.5	1.0	0.5
5-2-5	strength (Crimped connections)	Contact Wire Pulling load	Note> As for sizes in this define value	specifi	ication	

5-3. Environmental Performance and Others.

Item		Test Condition	Requi	rement
5-3-1		When mated up to 50 cycles repeatedly by the rate of 10 cycles per minute.	Contact Resistance	60 milliohms Max.



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Item		Test Condition	Requirement	
5-3-2	Temperature Rise	Carrying rated current load. (UL 1977)	Temperature rise	30°C Max.
		Amplitude: 1.5mm P-P Sweep time: 10~55~10 HZ in 1 minute Duration: 2 hours in each X.Y.Z axials.	Appearance	No Damage
			Contact Resistance	60 milliohms Max.
5-3-3	Vibration	(Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	Discontinuity	1 micro- second Max.
5-3-4	Shock	490m/s ² {50G}, 3 strokes in each X.Y.Z. axes. (Based upon EIA-364-27B/MIL-STD-202	Appearance	No Damage
			Contact Resistance	60 milliohms Max.
		Method 213B Cond.A)	Discontinuity	1 micro- second Max.
	Heat Resistance	85±2℃,96 hours. (Based upon MIL-STD-202 Method 108A Cond.A)	Appearance	No Damage
5-3-5			Contact Resistanc	60milliohms Max.
	Cold Resistance	-25±5℃,96 hours. (Based upon EIA-364-105)	Appearance	No Damage
5-3-6			Contact Resistanc	60milliohms Max.
	Humidity	Temperature: 40±2°C Relative Humidity: 90~95% Duration: 96 hours (Based upon EIA-364-31A/MIL-STD-202 Method 103B Cond.B)	Appearance	No Damage
5-3-7			Contact Resistance	60milliohms Max.
			Dielectric Strength	Must meet 5-1-3
			Insulation Resistance	100Megohms Min.
		(= 1	Appearance	No Damage
5-3-8	Temperature Cycling		Contact Resistance	60milliohms Max.



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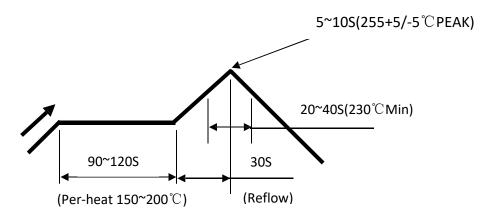
Item		Test Condition	Requirement	
5-3-9	Salt Spray	24 \pm 1 hours exposure to a salt spray from the 5 \pm 1% solution at 35 \pm 2 $^{\circ}$ C. (Based upon EIA-364-26A/MIL-STD-202 Method 101D Cond.B).	Appearance	No Damage
			Contact Resistance	60milliohms Max.
5-3-10	Solder- ability	Soldering Time: 5±0.5second. Solder Temperature: 245±5℃. (Based upon EIA-364-52)	Solder Wetting	95% of immersed area must show no voids, pin holes.
5-3-11	Solder- Resistance	Soldering time:5~10 sec solder. Temperature:255+5/-5°C. (Based upon EIA-364-56A)	Appearance	No Damage

6. INSERTION/WITHDRAWAL FORCE < Connector mating force>

No. of CKT	First Insertion (kgf Max.)	30 th Withdrawal (kgf Min.)	No. of CKT	First Insertion (kgf Max.)	30 th Withdrawal (kgf Min.)	
	Single row Series					
02	2.0	0.10	09	5.5	0.45	
03	2.5	0.15	10	6.0	0.50	
04	3.0	0.20	11	6.5	0.55	
05	3.5	0.25	12	7.0	0.60	
06	4.0	0.30	13	7.5	0.65	
07	4.5	0.35	14	8.0	0.70	
08	5.0	0.40	15	8.5	0.75	
Double row Series						
2*05	2.20	0.40	2*20	8.80	1.50	
2*10	4.40	0.80	2*25	11.00	1.90	
2*15	6.60	1.20				

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7. SMT SMT INFRARED REFLOW CONDITION



TEMPERATURE CONDITION GRAPH/ (TEMPERATURE ON BOARD PATTERNSIDE)

Notes: Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, P.C. boards, and so on. Note:Insertion and Withdrawal for 30Cycles